

APTB1612YSGC-F01

1.6 x 1.25 mm Bi-Color SMD Chip LED Lamp



PACKAGE DIMENSIONS

Polarity mark



DESCRIPTIONS

- · The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

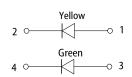
FEATURES

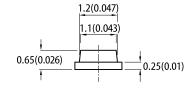
- 1.6 mm x 1.25 mm SMD LED, 0.65 mm thickness
- Bi-color, low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

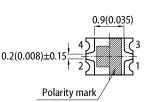
APPLICATIONS

- Backlight
- Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

LED Chip 1.6(0.063) 0.75(0.03 0.6(0.024) 1.25(0.049)

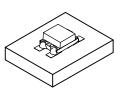


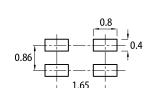




RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)





Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.2(0.008") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
			Min.	Тур.	201/2	
APTB1612YSGC-F01	Yellow (GaAsP/GaP)	Water Clear	3	8	150°	
	Super Bright Green (GaP)		5	12	150	

Notes

4. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

Kingbright

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Falameter			Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Yellow Super Bright Green	590 565	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Yellow Super Bright Green	588 568	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_{F} = 20mA	Δλ	Yellow Super Bright Green	35 30	-	nm
Forward Voltage I _F = 20mA	V _F ^[2]	Yellow Super Bright Green	2.1 2.2	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Yellow Super Bright Green	-	10 10	μΑ
Temperature Coefficient of λ_{peak} I _F = 20mA, -10°C \leq T \leq 85°C	ТС _{λреак}	Yellow Super Bright Green	0.12 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 20mA, -10°C \leq T \leq 85°C	TC _{λdom}	Yellow Super Bright Green	0.07 0.08	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	Yellow Super Bright Green	-2.0 -2.0	-	mV/°C

Notes:

noiss. 1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.) 2. Forward voltage: ±0.1V. 3. Wavelength value is traceable to CIE127-2007 standards. 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

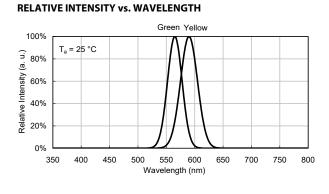
Parameter	Symbol	Va	Unit	
Parameter		Yellow	Super Bright Green	Unit
Power Dissipation	P _D	75	62.5	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	110	110	°C
Operating Temperature	T _{op}	-40 T	°C	
Storage Temperature	T _{stg}	-40 T	°C	
DC Forward Current	I _F	30 25		mA
Peak Forward Current	ا _{۶۹} [1]	140	140	mA
Electrostatic Discharge Threshold (HBM)	-	8000	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	800 750		°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	650	590	°C/W

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th Ja}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

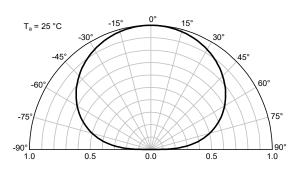
Kingbright

APTB1612YSGC-F01

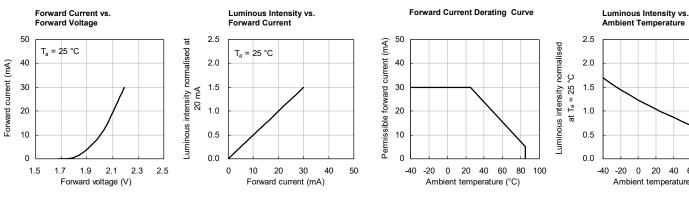
TECHNICAL DATA

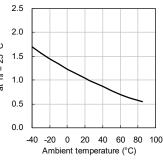


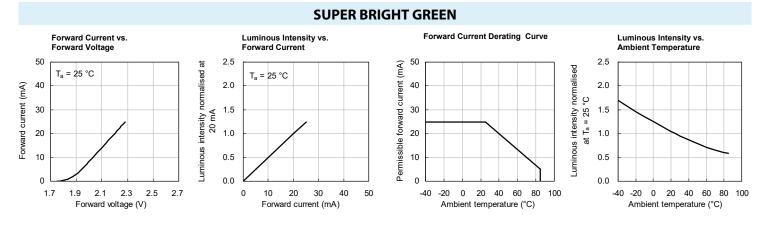
SPATIAL DISTRIBUTION



YELLOW



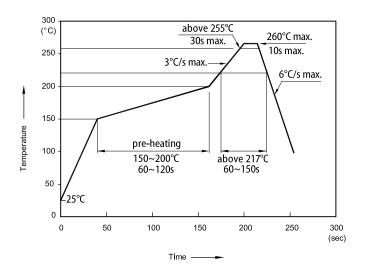




Kingbright

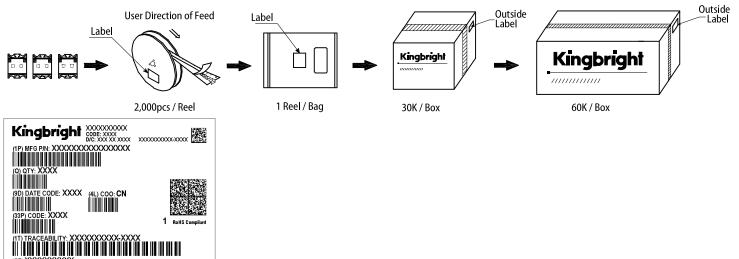
APTB1612YSGC-F01

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

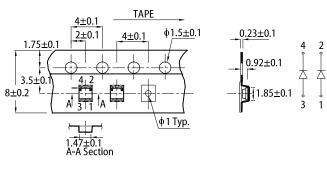


Cont cause stress to the LEDs while it is exposed to high temperature.
The maximum number of reflow soldering passes is 2 times.
Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

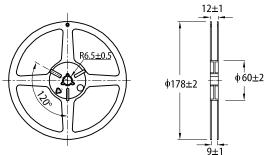
PACKING & LABEL SPECIFICATIONS



TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. 2
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits. Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- 4. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. All design applications should refer to Kingbright application notes available at <u>https://www.KingbrightUSA.com/Application</u> 5
- 6 Notes

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Kingbright:

APTB1612YSGC-F01